

## INFORMATION DISCLOSURE STATEMENT

**APPLICANTS:** 

Nakamura et al.

ATTORNEY DOCKET NO: P97,0322

**SERIAL NO.:** 

08/809,463

GROUP ART UNIT: 2814

FILED:

April 21, 1997

EXAMINER: N. Kelley\_

TITLE:

"MULTI-LAYERED STRUCTURE FOR FABRICATING AN OHMIC

ELECTRODE AND OHMIC ELECTRODE"

Hon. Asst. Commissioner for Patents,

Washington, D.C. 20231

SIR:

In accordance with the provisions of 37 C.F.R. § 1.56, Applicants request that citation and examination of the following documents be made during the course of examination of the above-referenced application for United States Letters Patent. These references are hereby submitted within three months of the date of the European Search Report for the corresponding Singapore Patent Application and additionally these documents are submitted prior to receipt of a First Official Action for this case, thus no fee is due in accordance with the provisions of 37 C.F.R. §1.97(b)(3).

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**U.S. DOCUMENTS** 

NOV 25 1998

**REFERENCE** 

U.S. PATENT NO. PATENTEE

ISSUE DATEGROUP 2100

AA

5,027,187

O'Mara, Jr. et al.

June 25, 1991

## **FOREIGN DOCUMENTS**

<u>REFERENCE</u>	DOCUMENT NO.	COUNTRY	PUBLICATION DATE
AL	0 559 182 A2	Europe	September 8, 1993
AM	0 649 167 A2	Europe	April 19, 1995

## **EXPLANATION OF RELEVANCE**

A copy of the above-identified references together with PTO Form 1449 are submitted herewith. A copy of the Search Report is also enclosed. Applicants submit all claims of the application are patentably distinguishable over the teaching of the above-references, taken alone or in combination. Early consideration of the application is therefore requested.

Submitted by,

(Reg. 17,074)

LEWIS T. STEADMAN
HILL & SIMPSON
A Professional Corporation
85th Floor - Sears Tower
Chicago, Illinois 60606

Telephone: 312/876-0200 - Ext. 3191 Attorneys for Applicants

## **CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class mail in an envelope addressed to: Hon. Assistant Commissioner for Patents Washington, D.C. 20231 on November 18, 1998.

LEWIS T. STEADMAN

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